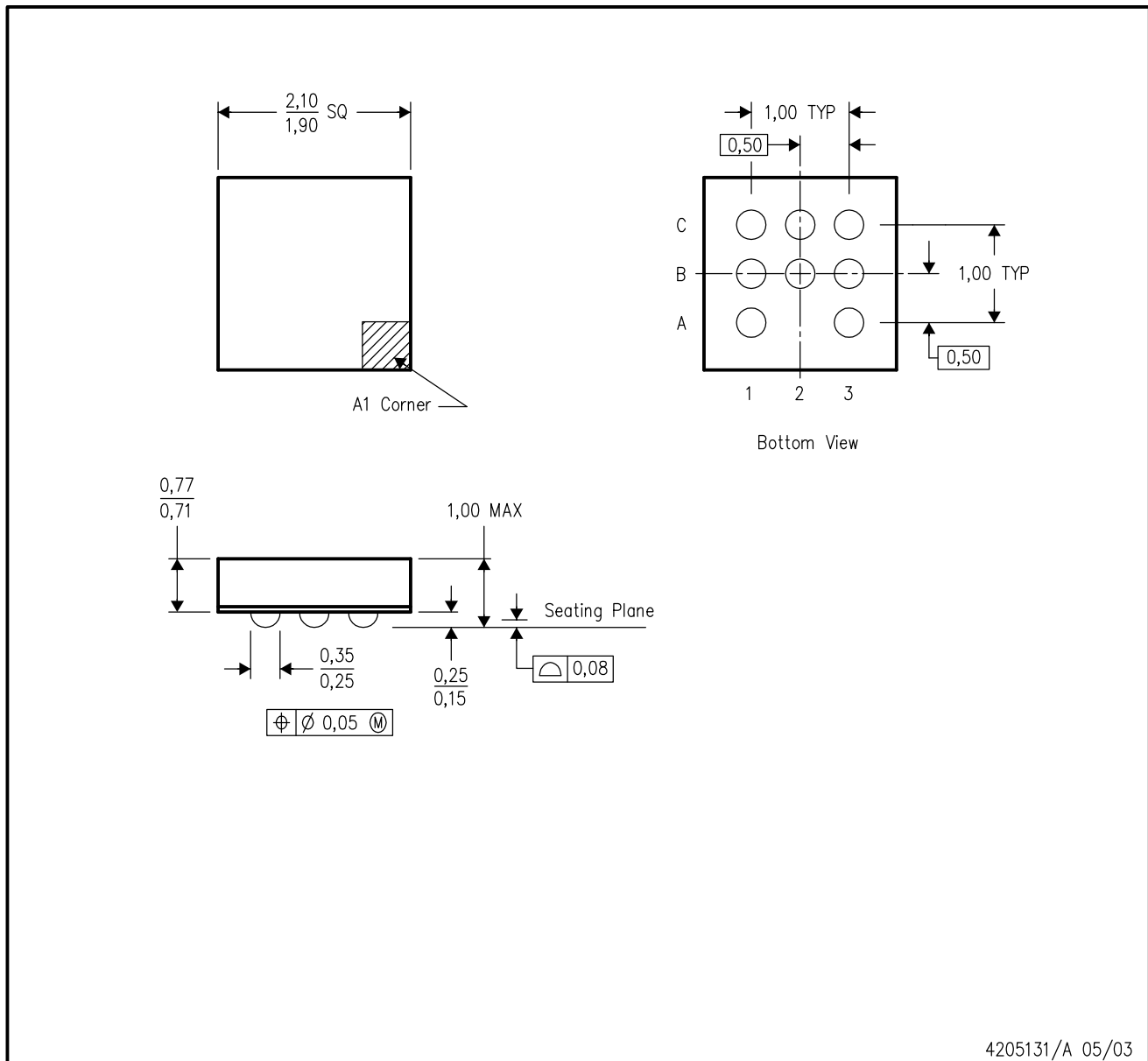


ZQV (S-PBGA-N8)

PLASTIC BALL GRID ARRAY



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - MicroStar Junior configuration
 - Falls within JEDEC MO-225
 - This package is lead-free.

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